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MARKING

# Single 3-Input OR Gate

# NL17SZ332

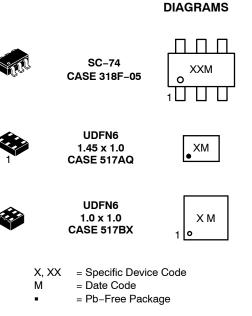
The NL17SZ332 is a single 3-input OR Gate in tiny footprint packages.

### Features

- Designed for 1.65 V to 5.5 V  $V_{CC}$  Operation
- 2.4 ns  $t_{PD}$  at  $V_{CC}$  = 5 V (Typ)
- Inputs/Outputs Overvoltage Tolerant up to 5.5 V
- I<sub>OFF</sub> Supports Partial Power Down Protection
- Source/Sink 24 mA at 3.0 V
- Chip Complexity < 100 FETs
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant



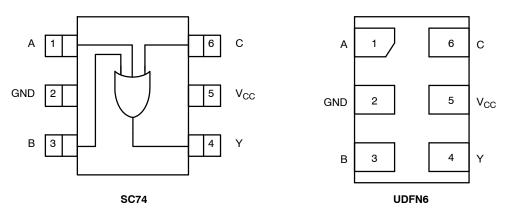
Figure 1. Logic Symbol

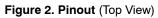


#### **ORDERING INFORMATION**

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet.

## NL17SZ332





#### **PIN ASSIGNMENT**

Pin	Function
1	A
2	GND
3	В
4	Y
5	V <sub>CC</sub>
6	С

#### **FUNCTION TABLE** (Y = A + B + C)

	Output		
Α	В	С	Y
Н	Х	Х	Н
Х	Н	Х	Н
Х	Х	Н	Н
L	L	L	L

H = HIGH Logic Level L = LOW Logic Level X = Either LOW or HIGH Logic Level

#### MAXIMUM RATINGS

Symbol	Characteristics		Value	Unit
V <sub>CC</sub>	DC Supply Voltage		–0.5 to +6.5	V
V <sub>IN</sub>	DC Input Voltage		-0.5 to +6.5	V
V <sub>OUT</sub>	DC Output Voltage	Active-Mode (High or Low State) Tri-State Mode (Note 1) Power-Down Mode (V <sub>CC</sub> = 0 V)	-0.5 to V <sub>CC</sub> + 0.5 -0.5 to +6.5 -0.5 to +6.5	V
I <sub>IK</sub>	DC Input Diode Current	V <sub>IN</sub> < GND	-50	mA
I <sub>OK</sub>	DC Output Diode Current	V <sub>OUT</sub> < GND	-50	mA
I <sub>OUT</sub>	DC Output Source/Sink Current		±50	mA
I <sub>CC</sub> or I <sub>GND</sub>	DC Supply Current per Supply Pin or Ground	Pin	±100	mA
T <sub>STG</sub>	Storage Temperature Range		-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 see	CS	260	°C
TJ	Junction Temperature Under Bias		+150	°C
$\theta_{JA}$	Thermal Resistance (Note 2)	SC-74 UDFN6	320 154	°C/W
PD	Power Dissipation in Still Air	SC-74 UDFN6	390 812	mW
MSL	Moisture Sensitivity		Level 1	-
F <sub>R</sub>	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	-
$V_{\text{ESD}}$	ESD Withstand Voltage (Note 3)	Human Body Model Charged Device Model	2000 1000	V
I <sub>Latchup</sub>	Latchup Performance (Note 4)		±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Applicable to devices with outputs that may be tri-stated.
 Measured with minimum pad spacing on an FR4 board, using 10mm-by-1inch, 2 ounce copper trace no air flow per JESD51-7.
 HBM tested to ANSI/ESDA/JEDEC JS-001-2017. CDM tested to EIA/JESD22-C101-F. JEDEC recommends that ESD qualification to EIA/JESD22-A115-A (Machine Model) be discontinued per JEDEC/JEP172A.

4. Tested to EIA/JESD78 Class II.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Characteristics		Min	Max	Unit
V <sub>CC</sub>	Positive DC Supply Voltage		1.65	5.5	V
V <sub>IN</sub>	DC Input Voltage		0	5.5	V
V <sub>OUT</sub>		tive-Mode (High or Low State) Tri-State Mode (Note 1) ower-Down Mode (V <sub>CC</sub> = 0 V)	0 0 0	V <sub>CC</sub> 5.5 5.5	
T <sub>A</sub>	Operating Temperature Range		-55	+125	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Time	$\begin{array}{l} V_{CC} = 1.65 \ V \ to \ 1.95 \ V \\ V_{CC} = 2.3 \ V \ to \ 2.7 \ V \\ V_{CC} = 3.0 \ V \ to \ 3.6 \ V \\ V_{CC} = 4.5 \ V \ to \ 5.5 \ V \end{array}$	0 0 0 0	20 20 10 5	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

#### DC ELECTRICAL CHARACTERISTICS

			Vcc	Т,	م = 25°0		–55°C ≤ T <sub>A</sub> ≤ 125°C		
Symbol	Parameter	Condition	(V)	Min	Тур	Max	Min	Max	Units
VIH	High-Level Input		1.65 to 1.95	0.65 V <sub>CC</sub>	-	_	0.65 V <sub>CC</sub>	_	V
	Voltage		2.3 to 5.5	0.70 V <sub>CC</sub>	-	-	0.70 V <sub>CC</sub>	-	
V <sub>IL</sub>	Low-Level Input		1.65 to 1.95	-	-	$0.35  V_{CC}$	-	$0.35  V_{CC}$	V
	Voltage		2.3 to 5.5	-	-	0.30 V <sub>CC</sub>	-	0.30 V <sub>CC</sub>	
V <sub>OH</sub>	High–Level Output Voltage	$ \begin{array}{l} V_{IN} = V_{IH} \mbox{ or } V_{IL} \\ I_{OH} = -100 \ \mu A \\ I_{OH} = -4 \ m A \\ I_{OH} = -8 \ m A \\ I_{OH} = -16 \ m A \\ I_{OH} = -24 \ m A \\ I_{OH} = -32 \ m A \end{array} $	1.65 to 5.5 1.65 2.3 3.0 3.0 4.5	V <sub>CC</sub> - 0.1 1.29 1.9 2.4 2.3 3.8	V <sub>CC</sub> 1.4 2.1 2.7 2.5 4.0	- - - - -	V <sub>CC</sub> - 0.1 1.29 1.9 2.4 2.3 3.8	- - - - -	V
V <sub>OL</sub>	Low-Level Output Voltage		1.65 to 5.5 1.65 2.3 3.0 3.0 4.5		- 0.08 0.2 0.28 0.38 0.42	0.1 0.24 0.3 0.4 0.55 0.55		0.1 0.24 0.3 0.4 0.55 0.55	V
I <sub>IN</sub>	Input Leakage Current	$V_{IN}$ = 5.5 V or GND	1.65 to 5.5	-	-	±0.1	-	±1.0	μA
I <sub>OFF</sub>	Power Off Leakage Current	V <sub>IN</sub> = 5.5 V or V <sub>OUT</sub> = 5.5 V	0	-	-	1.0	-	10	μΑ
I <sub>CC</sub>	Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND	5.5	-	-	1.0	-	10	μΑ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

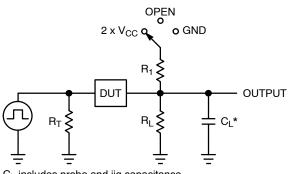
#### AC ELECTRICAL CHARACTERISTICS

			V <sub>CC</sub>	T,	<sub>A</sub> = 25°	С	–55°C ≤ T	գ ≤ 125°C	
Symbol	Parameter	Condition	(V)	Min	Тур	Max	Min	Max	Units
t <sub>PLH,</sub>		$R_L$ = 1 M $\Omega$ , $C_L$ = 15 pF	1.65 to 1.95	-	6.5	18.5	-	19.0	ns
tPHL		$R_L$ = 1 M $\Omega$ , $C_L$ = 15 pF	2.3 to 2.7	-	3.0	11.0	-	11.5	
		$R_L$ = 1 M $\Omega$ , $C_L$ = 15 pF	15 pF 3.0 to 3.6	-	2.4	7.5	-	8.0	
		$R_L$ = 500 $\Omega$ , $C_L$ = 50 pF		-	3.0	8.5	-	9.0	
		$R_L$ = 1 M $\Omega$ , $C_L$ = 15 pF	4.5 to 5.5	-	1.9	5.5	-	6.0	
		$R_L$ = 500 $\Omega$ , $C_L$ = 50 pF		-	2.4	7.0	-	7.5	

#### **CAPACITIVE CHARACTERISTICS**

Symbol	Parameter	Condition	Typical	Units
C <sub>IN</sub>	Input Capacitance	$V_{CC}$ = 5.5 V, $V_{IN}$ = 0 V or $V_{CC}$	2.5	pF
C <sub>OUT</sub>	Output Capacitance	$V_{CC}$ = 5.5 V, $V_{IN}$ = 0 V or $V_{CC}$	2.5	pF
C <sub>PD</sub>	Power Dissipation Capacitance (Note 5)	10 MHz, V <sub>CC</sub> = 3.3 V, V <sub>IN</sub> = 0 V or V <sub>CC</sub> 10 MHz, V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = 0 V or V <sub>CC</sub>	9 11	pF

5.  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation:  $I_{CC(OPR)} = C_{PD} \bullet V_{CC} \bullet f_{in} + I_{CC}$ .  $C_{PD}$  is used to determine the no-load dynamic power consumption;  $P_D = C_{PD} \bullet V_{CC}^2 \bullet f_{in} + I_{CC} \bullet V_{CC}$ .

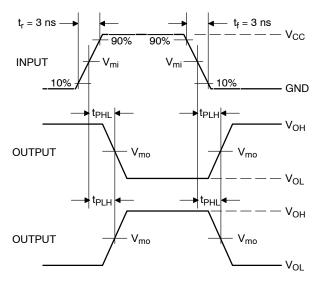


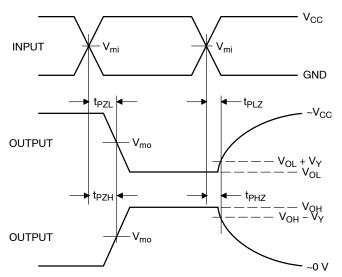
Switch Position	C <sub>L</sub> , pF	$R_{L}, \Omega$	R <sub>1</sub> , Ω	
Open	See AC Characteristics Table			
$2 \times V_{CC}$	50	500	500	
GND	50	500	500	
	Position Open 2 x V <sub>CC</sub>	Position      Entropy        Open      See AC Character        2 x V <sub>CC</sub> 50	Position      End        Open      See AC Characteristics Tat        2 x V <sub>CC</sub> 500	

X = Don't Care

 $C_L$  includes probe and jig capacitance  $R_T$  is  $Z_{OUT}$  of pulse generator (typically 50  $\Omega)$  f = 1 MHz

### Figure 3. Test Circuit





#### Figure 4. Switching Waveforms

		v		
V <sub>CC</sub> , V	V <sub>mi</sub> , V	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub> , t <sub>PZH</sub> , t <sub>PHZ</sub>	V <sub>Y</sub> , V
1.65 to 1.95	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	0.15
2.3 to 2.7	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	0.15
3.0 to 3.6	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	0.3
4.5 to 5.5	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	0.3

## NL17SZ332

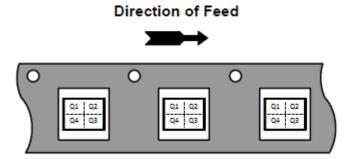
#### **DEVICE ORDERING INFORMATION**

Device	Packages	Specific Device Code	Pin 1 Orientation (See below)	Shipping <sup>†</sup>
NL17SZ332DBVT1G	SC-74	AE	Q4	3000 / Tape & Reel
NL17SZ332MU1TCG (In Development)	UDFN6, 1.45x1.0, 0.5P	6	Q4	3000 / Tape & Reel
NL17SZ332MU3TCG (In Development)	UDFN6, 1.0x1.0, 0.35P	6	Q4	3000 / Tape & Reel

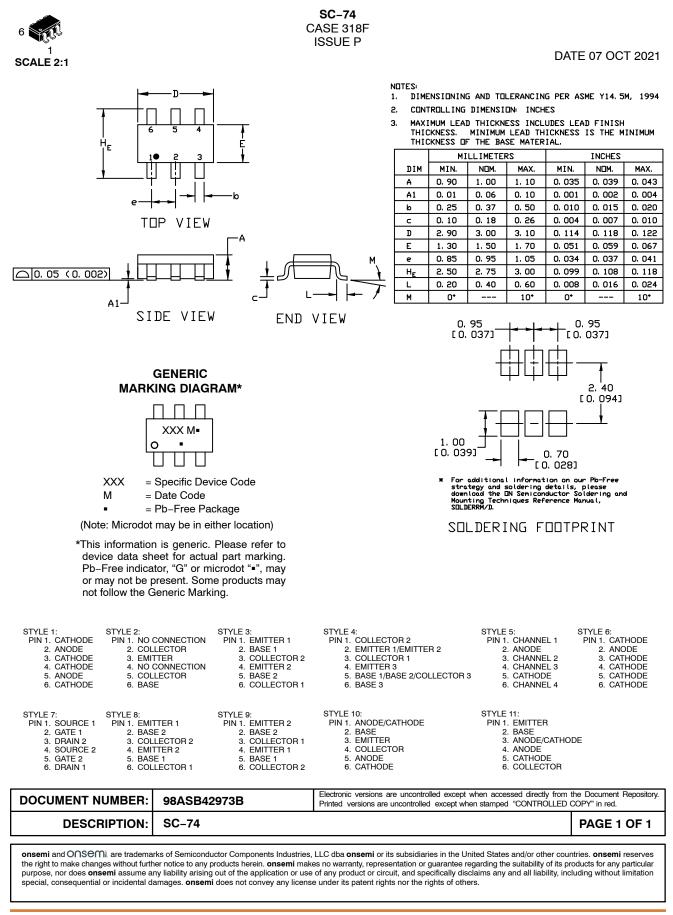
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable.

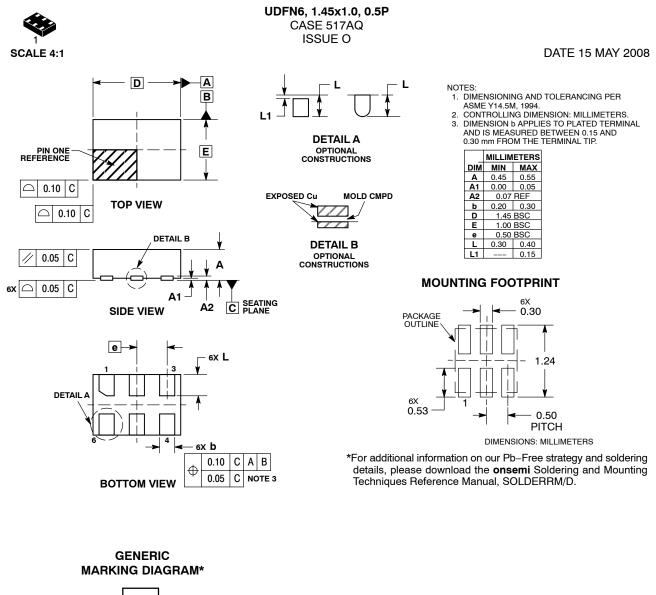
### **PIN 1 ORIENTATION IN TAPE AND REEL**



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XM

= Specific Device Code

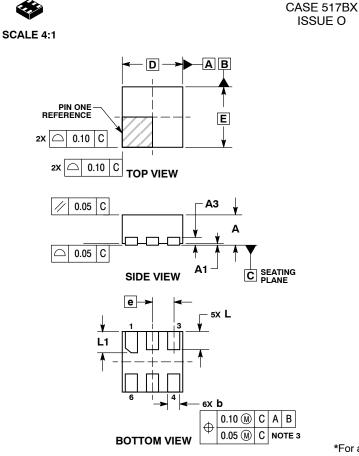
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\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " .", may or may not be present.

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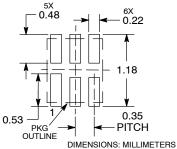
#### DATE 18 MAY 2011

NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

- CONTROLLING DIMENSION: MILLIMETERS.
  DIMENSION 6 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN
- 0.15 AND 0.20 MM FROM TERMINAL TIP. 4. PACKAGE DIMENSIONS EXCLUSIVE OF BURRS AND MOLD FLASH.

1	BURRS AND MOLD FL					
		MILLIN	MILLIMETERS			
	DIM	MIN	MAX			
	Α	0.45	0.55			
	A1	0.00	0.05			
	A3	0.13	REF			
	b	0.12	0.22			
	D	1.00	BSC			
	Е	1.00 BSC				
	е	0.35 BSC				
	L	0.25	0.35			
	L1	0.30	0.40			

#### RECOMMENDED SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### GENERIC MARKING DIAGRAM\*



X = Specific Device Code M = Date Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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UDFN6, 1x1, 0.35P

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